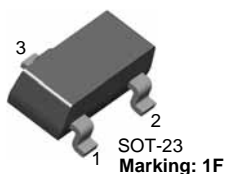


MMBT5550

NPN General Purpose Amplifier

- This device is designed for general purpose high voltage amplifiers and gas discharge display drivers.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings * $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------|----------------------------------|------------|------------------|
| V_{CEO} | Collector-Emitter Voltage | 140 | V |
| V_{CBO} | Collector-Base Voltage | 160 | V |
| V_{EBO} | Emitter-Base Voltage | 6.0 | V |
| I_C | Collector current - Continuous | 600 | mA |
| T_J, T_{stg} | Junction and Storage Temperature | -55 ~ +150 | $^\circ\text{C}$ |

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- These ratings are based on a maximum junction temperature of 150 degrees C.
- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|----------------------------|---------------------------------------|--|----------------|--------------|---------------------|
| Off Characteristics | | | | | |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage * | $I_C = 1.0\text{mA}, I_B = 0$ | 140 | | V |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C = 100\mu\text{A}, I_E = 0$ | 160 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 10\text{mA}, I_C = 0$ | 6.0 | | V |
| I_{CBO} | Collector Cutoff Current | $V_{CB} = 100\text{V}, I_E = 0$ $V_{CB} = 100\text{V}, I_E = 0, T_a = 100^\circ\text{C}$ | | 100 100 | nA μA |
| I_{EBO} | Emitter Cutoff Current | $V_{EB} = 4.0\text{V}, I_C = 0$ | | 50 | nA |
| On Characteristics | | | | | |
| h_{FE} | DC Current Gain | $I_C = 1.0\text{mA}, V_{CE} = 5.0\text{V}$ $I_C = 10\text{mA}, V_{CE} = 5.0\text{V}$ $I_C = 50\text{mA}, V_{CE} = 5.0\text{V}$ | 60 60 20 | 250 | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$ | | 0.15 0.25 | V V |
| $V_{BE(sat)}$ | Base-Emitter On Voltage | $I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$ | | 1.0 1.2 | V V |

Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|-------------------------------------|--------------------------------|--|------|------|-------|
| Small Signal Characteristics | | | | | |
| f_T | Current Gain Bandwidth Product | $I_C = 10\text{mA}$, $V_{CE} = 10\text{V}$, $f = 100\text{MHz}$ | 50 | | MHz |
| C_{obo} | Output Capacitance | $V_{CB} = 10\text{V}$, $I_E = 0$, $f = 1.0\text{MHz}$ | | 6.0 | pF |
| C_{ibo} | Input Capacitance | $V_{BE} = 0.5\text{V}$, $I_C = 0$, $f = 1.0\text{MHz}$ | | 30 | pF |

Thermal Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Max. | Units |
|-----------------|---|------------|----------------------------|
| P_D | Total Device Dissipation Derate above 25°C | 350 2.8 | mW mW/ $^\circ\text{C}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 357 | $^\circ\text{C/W}$ |

* Device mounted on FR-4 PCB $1.6'' \times 1.6'' \times 0.06''$ **Package Marking and Ordering Information**

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------|---------|-----------|------------|----------|
| 1F | MMBT5550 | SOT-23 | 7" | -- | 3,000 |

Typical Performance Characteristics

Figure 1. Typical Pulsed Current Gain vs Collector Current

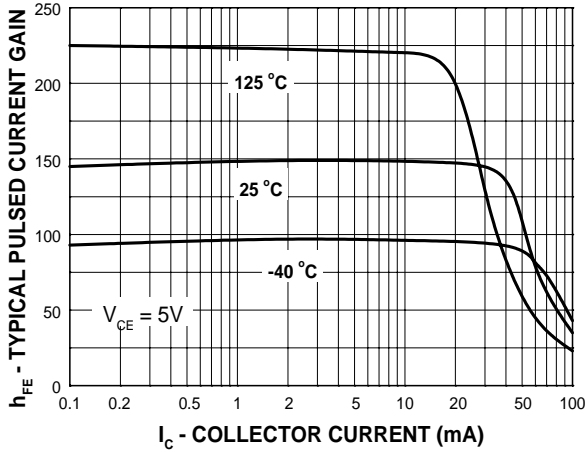


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

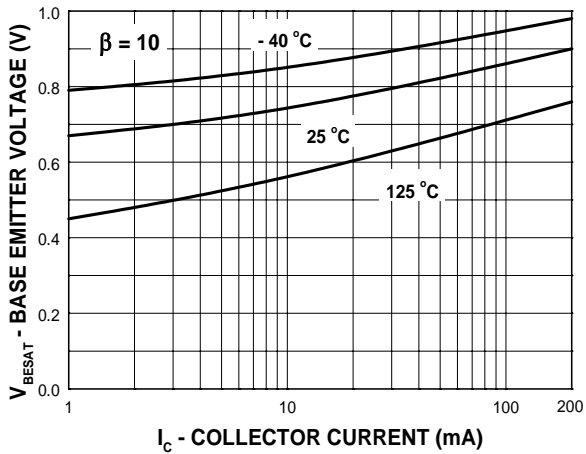


Figure 5. Collector Cutoff Current vs Ambient Temperature

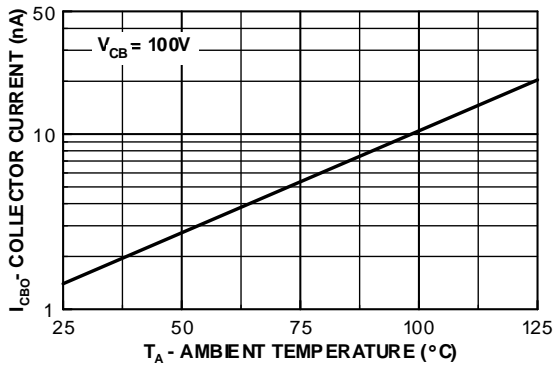


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

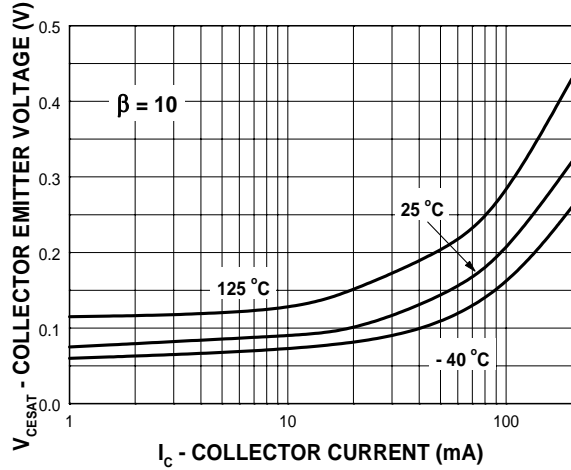


Figure 4. Base-Emitter On Voltage vs Collector Current

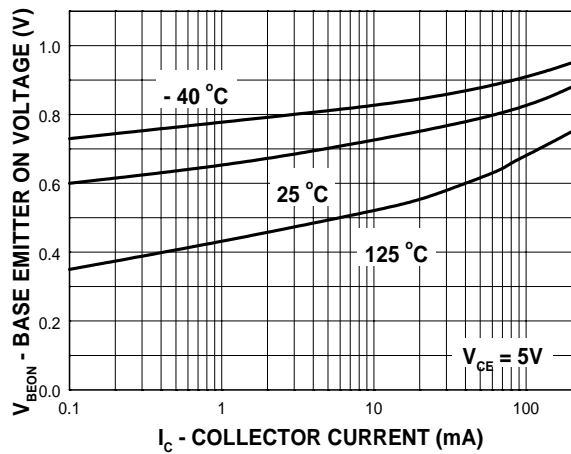
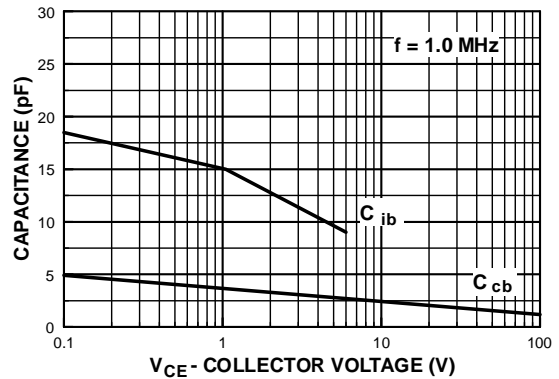
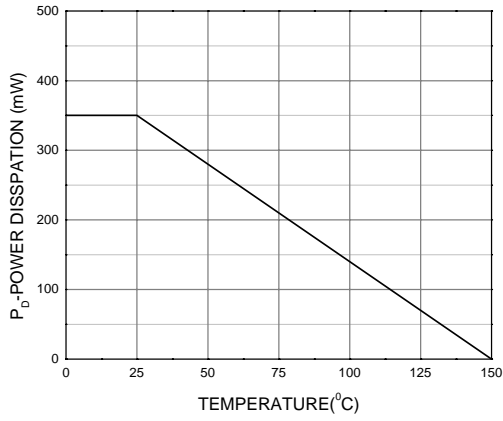


Figure 6. Input and Output Capacitance vs Reverse Voltage



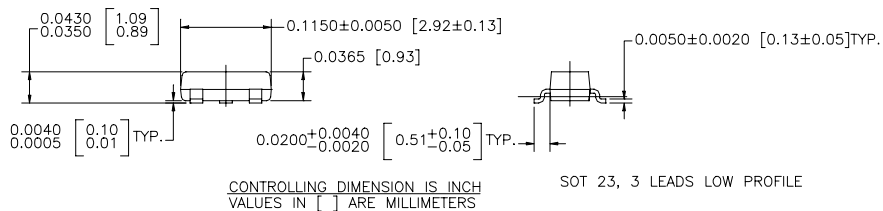
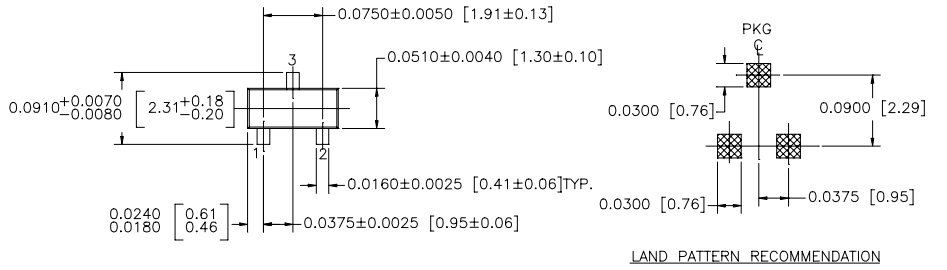
Typical Performance Characteristics (Continued)

Figure 7. Power Dissipation vs Ambient Temperature



Mechanical Dimensions

SOT-23



NOTE : UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH 150 MICRONS / 3.81 MICROMETERS
MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

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